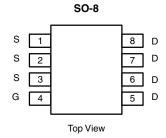




Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ Max.	I _D (A) ^d	Q _g (Typ.)		
- 30	0.0060 at V _{GS} = - 10 V	- 25.7	65 nC		
- 30	0.0080 at V _{GS} = - 4.5 V	- 22.3	65 110		



Ordering Information:

Si4101DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

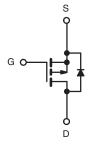
- TrenchFET® Power MOSFET
- 100 % R_a and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



HALOGEN FREE

APPLICATIONS

- · Adaptor Switch, Load Switch
- **Power Management**
- Notebook Computers and Portable Battery Packs



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (7	$\Gamma_A = 25 ^{\circ}\text{C}$, unless oth	erwise noted)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 25.7	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		- 20.6	
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	'D	- 18 ^{a, b}	
	T _A = 70 °C		- 14.4 ^{a, b}	A
Pulsed Drain Current (t = 300 μs)	I _{DM}	- 70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	- 5	
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S	- 2.4 ^{a, b}	
Avalanche Current	1 0.1 ml l	I _{AS}	- 30	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	45	mJ
	T _C = 25 °C		6	
Maximum Dawar Dissination	T _C = 70 °C	P _D	3.8	w
Maximum Power Dissipation	T _A = 25 °C		2.9 ^{a, b}	VV
	T _A = 70 °C	1	1.9 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	36	43	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	16	21	C/VV	

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 84 °C/W.
- d. Based on T_C = 25 °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		5.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	1	V _{DS} = - 30 V, V _{GS} = 0 V			-1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α	
D : 0	_	V _{GS} = - 10 V, I _D = - 15 A		0.0050	0.0060	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 10 A		0.0066	0.0080		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 15 A		72		S	
Dynamic ^b							
Input Capacitance	C _{iss}			8190			
Output Capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		772		pF	
Reverse Transfer Capacitance	C _{rss}			715			
Total Cata Charge	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -18 \text{ A}$		135	203		
Total Gate Charge	Q _g V _{DS} = 13 V, V _{GS} = 10 V, I _D = 10 A		65	85	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -18 \text{ A}$		22.5		nc nc	
Gate-Drain Charge	Q _{gd}			17.6			
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		9	18		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		80	120		
Fall Time	t _f			11	20	no	
Turn-On Delay Time	t _{d(on)}			72	108	ns	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		60	90		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		60	90		
Fall Time	t _f			23	35		
Drain-Source Body Diode Characteris	stics						
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			- 5	Λ.	
Pulse Diode Forward Current	I _{SM}				- 70	A	
Body Diode Voltage	V_{SD}	I _S = - 3 A, V _{GS} = 0 V		- 0.78	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			29	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 - 10 A dl/dt - 100 A/up T 05 °C		19	29	nC	
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$		13		nc	
Reverse Recovery Rise Time	t _b	<u> </u>		16		ns	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

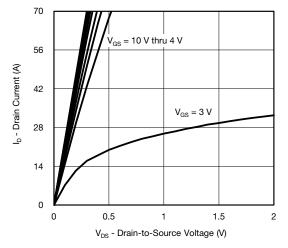
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

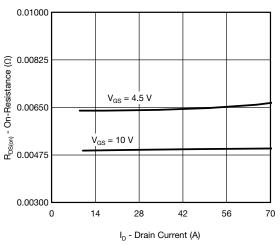


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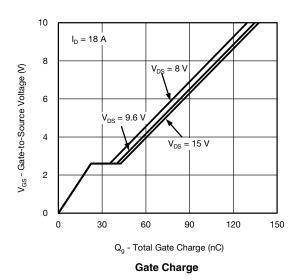
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

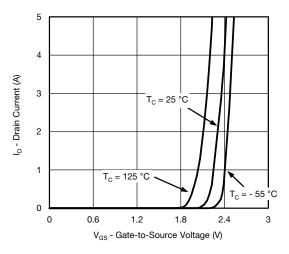


Output Characteristics

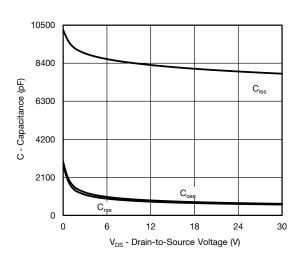


On-Resistance vs. Drain Current

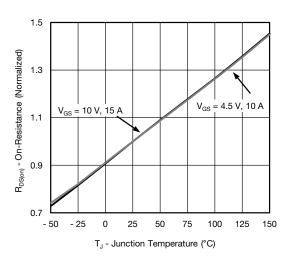




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

0.014

0.011

0.008

Si4101DY

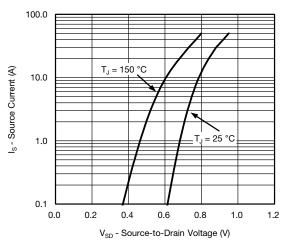
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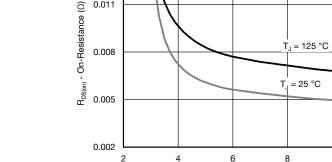
I_D = 15 A

10

T_{.1} = 125 °C

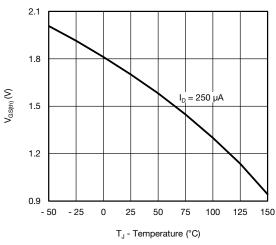
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

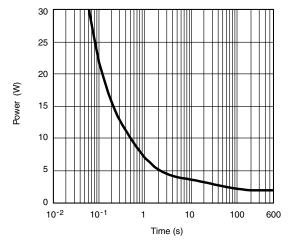




Source-Drain Diode Forward Voltage

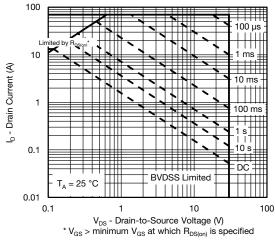






Threshold Voltage

Single Pulse Power, Junction-to-Ambient

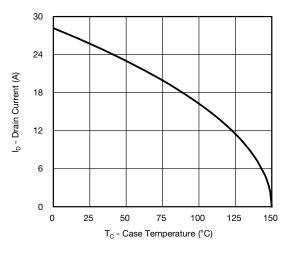


Safe Operating Area

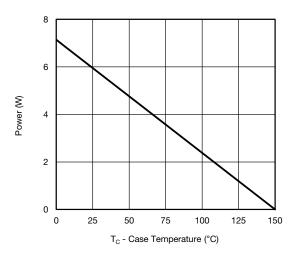


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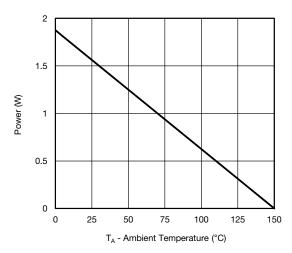
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*







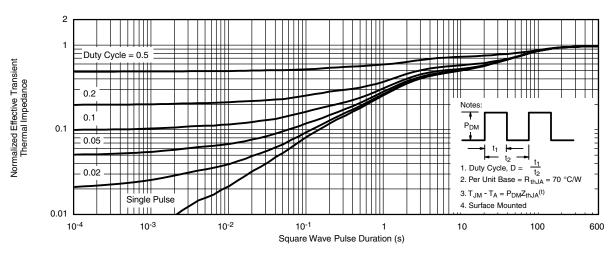
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

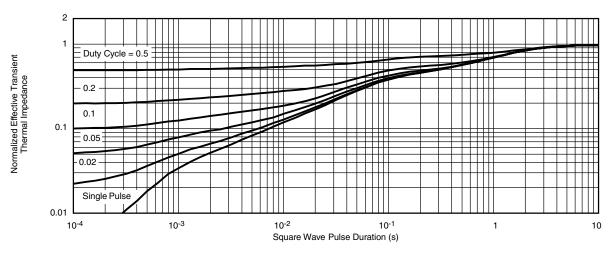
Si4101DY

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



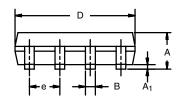
Normalized Thermal Transient Impedance, Junction-to-Foot

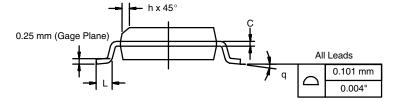
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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